

**Product Summary** (@ T<sub>A</sub> = +25°C)

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F(MAX)</sub> (V)	I <sub>R(MAX)</sub> (mA)
60	5	0.52	0.5

**Applications**

- SMPS
- AC-DC
- DC-DC Converter
- Freewheeling Diodes

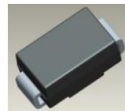
**Features and Benefits**

- Low Leakage Current
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

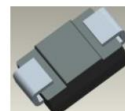
**Mechanical Data**

- Case: SMA
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208<sup>(3)</sup>
- Polarity Indicator: Cathode Band
- Weight: 0.064 grams (Approximate)

SMA



Top View



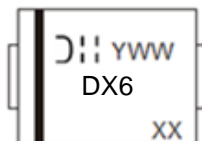
Bottom View

**Ordering Information** (Note 4)

Part Number	Compliance	Case	Packaging
SDT5A60SA-13	Commercial	SMA	10,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

**Marking Information**



- DX6 = Product Type Marking Code
- YWW = Manufacturers' Code Marking
- YWW = Date Code Marking
- Y = Last Digit of Year (ex: 9 for 2019)
- WW = Week Code 01 to 52
- XX = Foundry and Assembly Site

- Note: 5. Device has a cathode band (as shown) and may also have a cathode notch.

### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	60	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>RM</sub>		
Average Rectified Output Current	I <sub>O</sub>	5	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	60	A

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Ambient (Note 6)	R <sub>θJA</sub>	56	°C/W
Thermal Resistance Junction to Case (Note 6)	R <sub>θJC</sub>	27	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	—	0.46	0.52	V	I <sub>F</sub> = 5.0A, T <sub>J</sub> = +25°C
			0.39	0.45		I <sub>F</sub> = 5.0A, T <sub>J</sub> = +125°C
Leakage Current (Note 7)	I <sub>R</sub>	—	—	0.5	mA	V <sub>R</sub> = 60V, T <sub>J</sub> = +25°C
			50	—		V <sub>R</sub> = 60V, T <sub>J</sub> = +125°C

Notes: 6. FR-4 substrate, 1"\*1", 2oz, single-sided, PC boards with 0.56"\*0.73" copper pad.  
7. Short duration pulse test used to minimize self-heating effect.

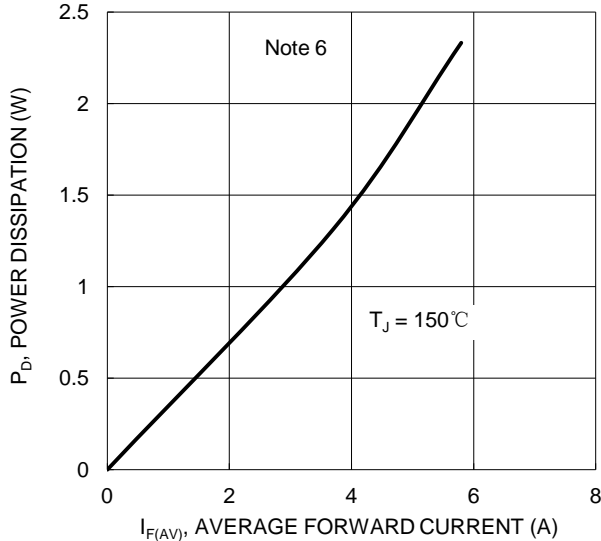


Figure 1. Forward Power Dissipation

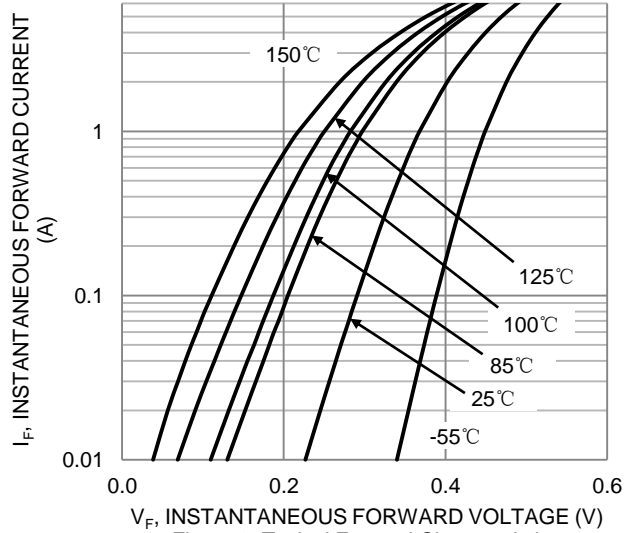


Figure 2. Typical Forward Characteristics

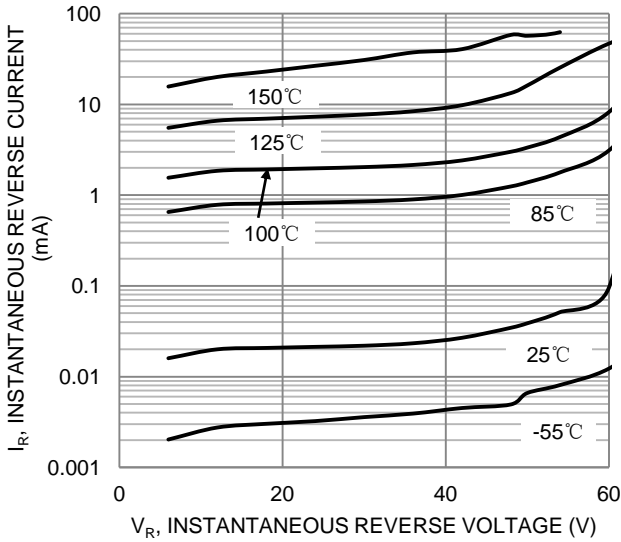


Figure 3. Typical Reverse Characteristics

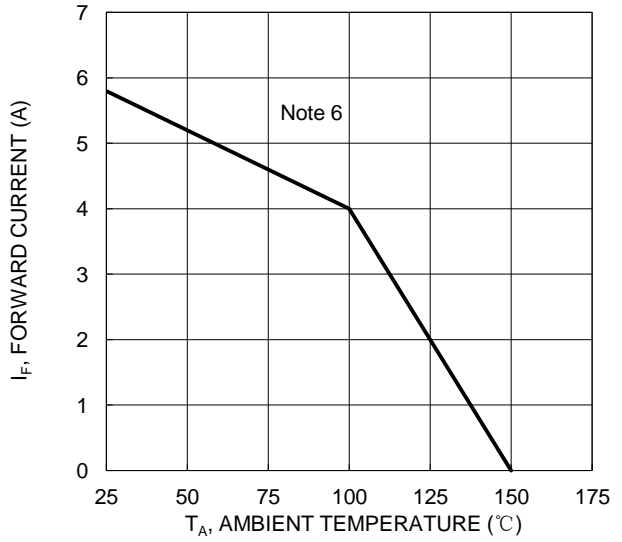
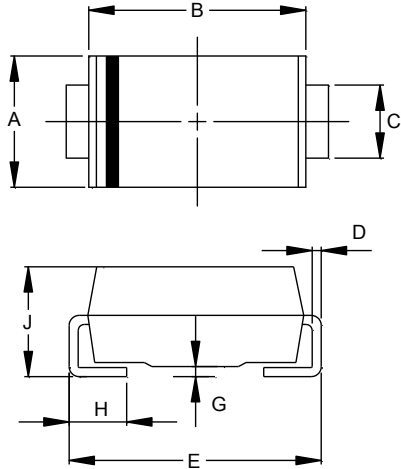


Figure 4. Forward Current Derating Curve

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SMA**



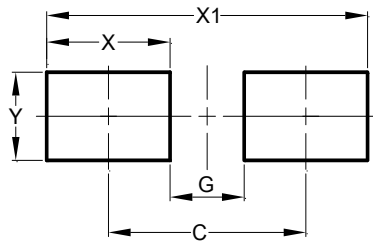
SMA		
Dim	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	1.96	2.40
All Dimensions in mm		

NEW PRODUCT

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SMA**



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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